

# 4 OUTPUT PCIE GEN1-2-3 SYNTHESIZER

IDT5V41346

## Recommended Applications

4 Output synthesizer for PCIe Gen1-2-3

## General Description

The IDT5V41346 is a PCIe Gen1/2/3 compliant spread-spectrum-capable clock generator. The device has 4 differential HCSL outputs and can be used in communication or embedded systems to substantially reduce electro-magnetic interference (EMI). The spread amount and output frequency are selectable via select pins.

## Output Features

- 4 - HCSL output pairs

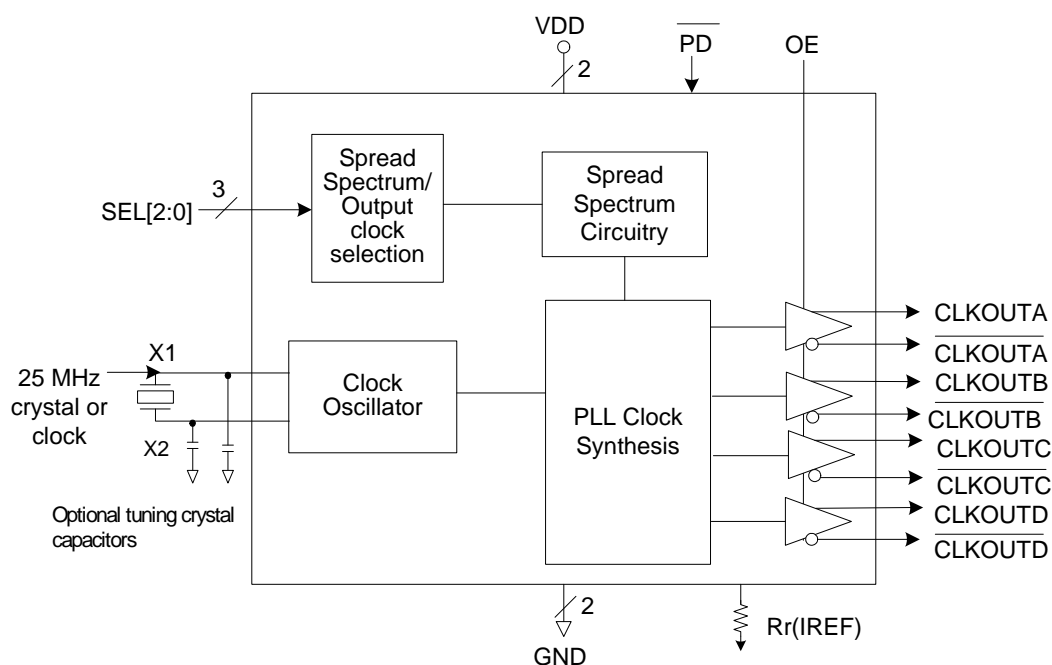
## Features/Benefits

- 20-pin TSSOP package; small board footprint
- Spread-spectrum capable; reduces EMI
- Outputs can be terminated to LVDS; can drive a wider variety of devices
- Power down pin; greater system power management
- OE control pin; greater system power management
- Spread% and frequency pin selection; no software required to configure device
- Industrial temperature range available; supports demanding embedded applications

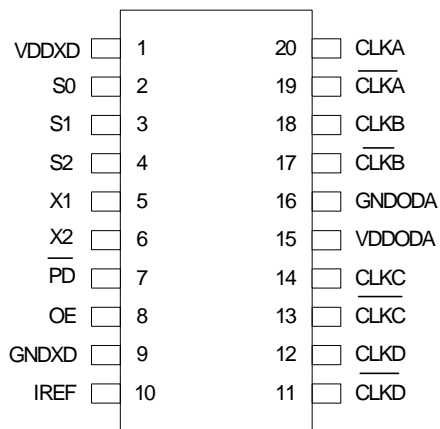
## Key Specifications

- Cycle-to-cycle jitter <50 ps
- Output-to-output skew <50 ps
- Low phase noise: 12 kHz to 20 MHz <6ps with spread off
- PCIe Gen1 peak-to-peak phase jitter <86ps
- PCIe Gen2 phase jitter <3.0ps RMS
- PCIe Gen3 phase jitter <1.0ps RMS

## Block Diagram



## Pin Assignment



20-pin (173 mil) TSSOP

## Spread Spectrum Selection Table

S2	S1	S0	Spread%	Spread Type	Output Frequency
0	0	0	-0.5	Down	100
0	0	1	-1.0	Down	100
0	1	0	-1.5	Down	100
0	1	1	No Spread	Not Applicable	100
1	0	0	-0.5	Down	200
1	0	1	-1.0	Down	200
1	1	0	-1.5	Down	200
1	1	1	No Spread	Not Applicable	200

## Pin Descriptions

Pin	Pin Name	Pin Type	Pin Description
1	VDDXD	Power	Connect to +3.3 V digital supply.
2	S0	Input	Spread spectrum select pin #0. See table above. Internal pull-up resistor.
3	S1	Input	Spread spectrum select pin #1. See table above. Internal pull-up resistor.
4	S2	Input	Spread spectrum select pin #2. See table above. Internal pull-up resistor.
5	X1	Input	Crystal connection. Connect to a fundamental mode crystal or clock input.
6	X2	Output	Crystal connection. Connect to a fundamental mode crystal or leave open.
7	PD	Input	Powers down all PLL's and tri-states outputs when low. Internal pull-up resistor.
8	OE	Input	Provides output on, tri-states output (High = enable outputs; Low = disable outputs). Internal pull-up resistor.
9	GND	Power	Connect to digital ground.
10	IREF	Output	Precision resistor attached to this pin is connected to the internal current reference.
11	CLKD	Output	Selectable 100/200 MHz spread spectrum differential Complement output clock D.
12	CLKD	Output	Selectable 100/200 MHz spread spectrum differential True output clock D.
13	CLKC	Output	Selectable 100/200 MHz spread spectrum differential Complement output clock C.
14	CLKC	Output	Selectable 100/200 MHz spread spectrum differential True output clock C.
15	VDDODA	Power	Connect to +3.3 V analog supply.
16	GND	Power	Connect to analog ground.
17	CLKB	Output	Selectable 100/200 MHz spread spectrum differential Complement output clock B.
18	CLKB	Output	Selectable 100/200 MHz spread spectrum differential True output clock B.
19	CLKA	Output	Selectable 100/200 MHz spread spectrum differential Complement output clock A.
20	CLKA	Output	Selectable 100/200 MHz spread spectrum differential True output clock A.

## Application Information

### Decoupling Capacitors

As with any high-performance mixed-signal IC, the IDT5V41346 must be isolated from system power supply noise to perform optimally.

Decoupling capacitors of  $0.01\mu\text{F}$  must be connected between each VDD and the PCB ground plane.

### PCB Layout Recommendations

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

Each  $0.01\mu\text{F}$  decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible. No vias should be used between decoupling capacitor and VDD pin. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via. Distance of the ferrite bead and bulk decoupling from the device is less critical.

2) An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers (the ferrite bead and bulk decoupling capacitor can be mounted on the back). Other signal traces should be routed away from the IDT5V41346.

This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

### External Components

A minimum number of external components are required for proper operation. Decoupling capacitors of  $0.01\mu\text{F}$  should be connected between VDD and GND pairs (1,9 and 15,16) as close to the device as possible.

### Current Reference Source $R_r$ ( $I_{ref}$ )

If board target trace impedance ( $Z$ ) is  $50\Omega$ , then  $R_r = 475\Omega$  (1%), providing  $I_{REF}$  of 2.32 mA, output current ( $I_{OH}$ ) is equal to  $6 \cdot I_{REF}$ .

### Load Resistors $R_L$

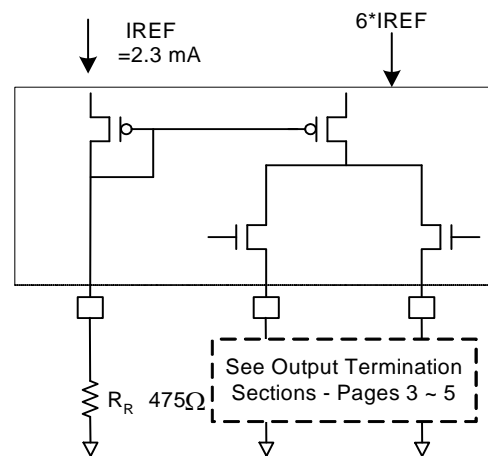
Since the clock outputs are open source outputs, 50 ohm external resistors to ground are to be connected at each clock output.

### Output Termination

The PCI-Express differential clock outputs of the IDT5V41346 are open source drivers and require an external series resistor and a resistor to ground. These resistor values and their allowable locations are shown in detail in the **PCI-Express Layout Guidelines** section.

The IDT5V41346 can also be configured for LVDS compatible voltage levels. See the **LVDS Compatible Layout Guidelines** section.

### Output Structures



### General PCB Layout Recommendations

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

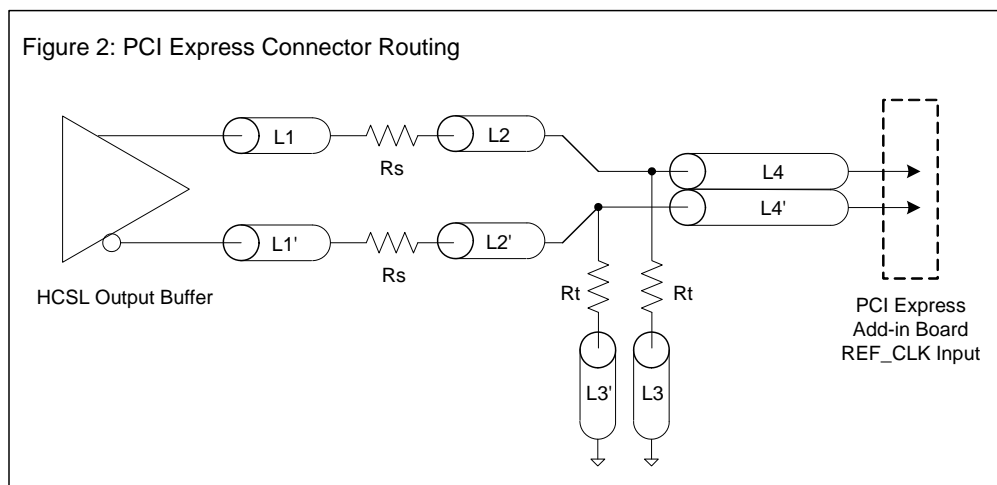
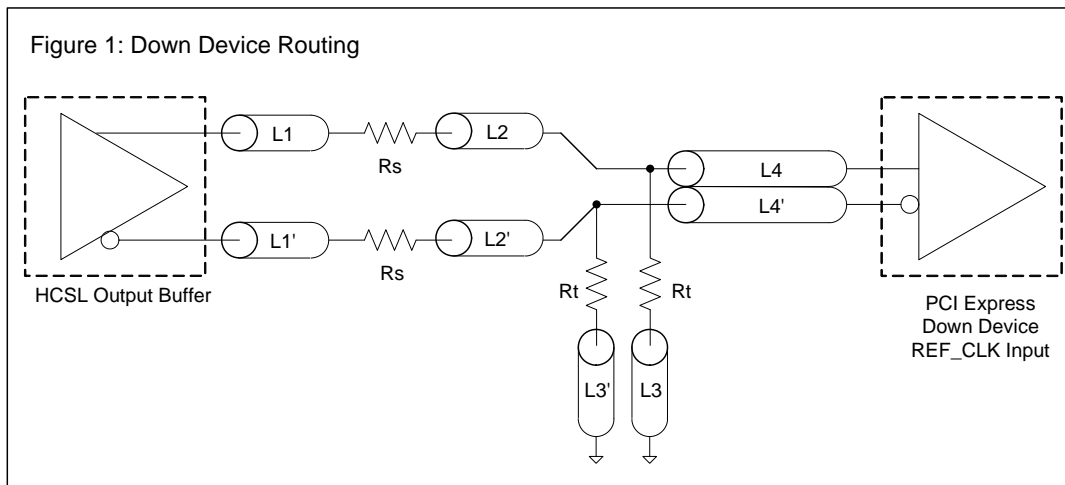
1. Each  $0.01\mu\text{F}$  decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible.
2. No vias should be used between decoupling capacitor and VDD pin.
3. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via. Distance of the ferrite bead and bulk decoupling from the device is less critical.
4. An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers (any ferrite beads and bulk decoupling capacitors can be mounted on the back). Other signal traces should be routed away from the IDT5V41346. This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

## Layout Guidelines

SRC Reference Clock			
Common Recommendations for Differential Routing	Dimension or Value	Unit	Figure
L1 length, route as non-coupled 50ohm trace	0.5 max	inch	1
L2 length, route as non-coupled 50ohm trace	0.2 max	inch	1
L3 length, route as non-coupled 50ohm trace	0.2 max	inch	1
Rs	33	ohm	1
Rt	49.9	ohm	1

Down Device Differential Routing			
L4 length, route as coupled microstrip 100ohm differential trace	2 min to 16 max	inch	1
L4 length, route as coupled stripline 100ohm differential trace	1.8 min to 14.4 max	inch	1

Differential Routing to PCI Express Connector			
L4 length, route as coupled microstrip 100ohm differential trace	0.25 to 14 max	inch	2
L4 length, route as coupled stripline 100ohm differential trace	0.225 min to 12.6 max	inch	2

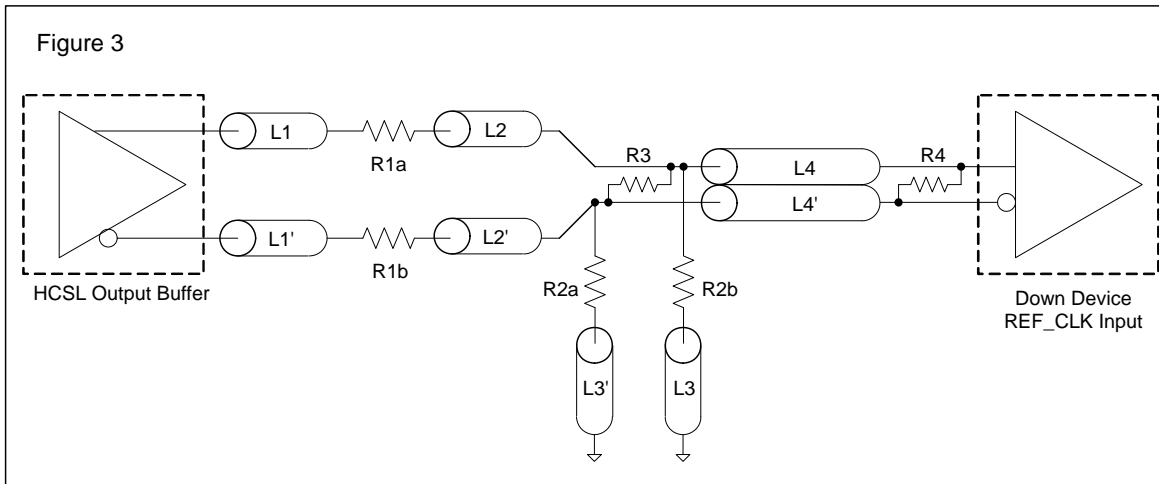


**Alternative Termination for LVDS and other Common Differential Signals (figure 3)**

Vdiff	Vp-p	Vcm	R1	R2	R3	R4	Note
0.45v	0.22v	1.08	33	150	100	100	
0.58	0.28	0.6	33	78.7	137	100	
0.80	0.40	0.6	33	78.7	none	100	ICS874003i-02 input compatible
0.60	0.3	1.2	33	174	140	100	Standard LVDS

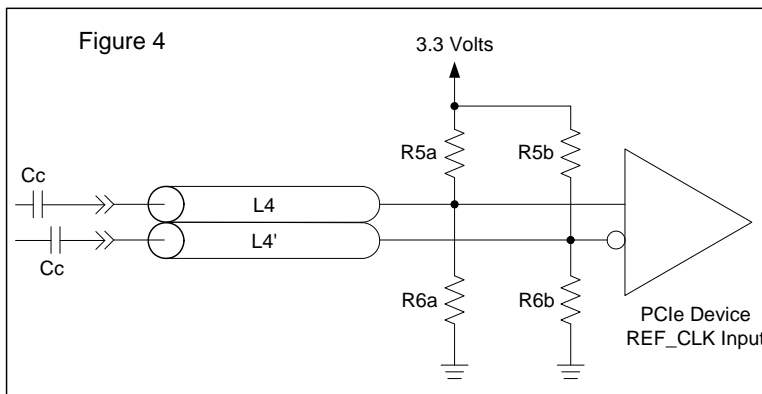
R1a = R1b = R1

R2a = R2b = R2

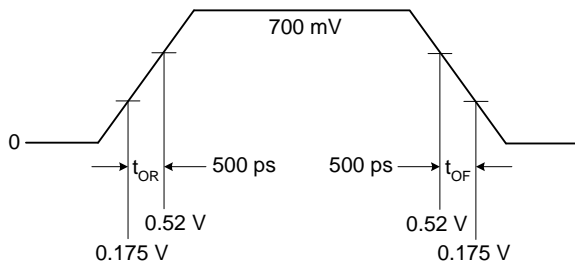


**Cable Connected AC Coupled Application (figure 4)**

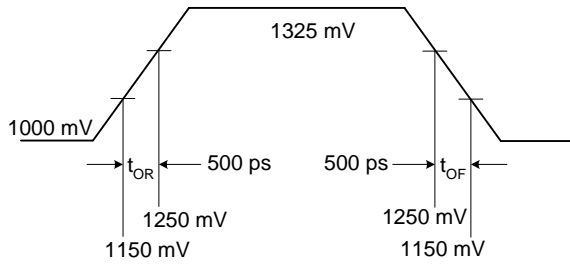
Component	Value	Note
R5a, R5b	8.2K 5%	
R6a, R6b	1K 5%	
Cc	0.1 $\mu$ F	
Vcm	0.350 volts	



### Typical PCI-Express (HCSL) Waveform



### Typical LVDS Waveform



## Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the IDT5V41346. These ratings are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD, VDDA	5.5 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature (commercial)	0 to +70°C
Ambient Operating Temperature (industrial)	-40 to +85°C
Storage Temperature	-65 to +150°C
Junction Temperature	125°C
Soldering Temperature	260°C
ESD Protection (Input)	2000 V min. (HBM)

## DC Electrical Characteristics

Unless stated otherwise, VDD = 3.3 V  $\pm$ 5%, Ambient Temperature 0 to +70°C or -40 to +85°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Supply Voltage	V		3.135	3.3	3.465	
Input High Voltage <sup>1</sup>	V <sub>IH</sub>		2.2		VDD +0.3	V
Input Low Voltage <sup>1</sup>	V <sub>IL</sub>		VSS-0.3		0.8	V
Input Leakage Current <sup>2</sup>	I <sub>IL</sub>	0 < V <sub>in</sub> < VDD	-5		5	$\mu$ A
Operating Supply Current @ 100 MHz	I <sub>DD</sub>	R <sub>S</sub> =33 $\Omega$ , R <sub>P</sub> =50 $\Omega$ , C <sub>L</sub> =2 pF		125	150	mA
	I <sub>DDOE</sub>	OE =Low		51	65	mA
	I <sub>DDPD</sub>	No load, $\overline{PD}$ =Low		350	550	$\mu$ A
Input Capacitance	C <sub>IN</sub>	Input pin capacitance			7	pF
Output Capacitance	C <sub>OUT</sub>	Output pin capacitance			6	pF
X1, X2 Capacitance	C <sub>INX</sub>				5	pF
Pin Inductance	L <sub>PIN</sub>				5	nH
Output Impedance	Z <sub>o</sub>	CLK outputs	3.0			k $\Omega$
Pull-up Resistance	R <sub>PUP</sub>	OE, SEL, $\overline{PD}$ pins		100		k $\Omega$

1. Single edge is monotonic when transitioning through region.
2. Inputs with pull-ups/-downs are not included.



## AC Electrical Characteristics - CLKOUT (A:D)

Unless stated otherwise,  $V_{DD}=3.3\text{ V} \pm 5\%$ , Ambient Temperature 0 to +70°C or -40 to +85°C

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Input Frequency				25		MHz
Output Frequency		HCSL termination	100		200	MHz
		LVDS termination	100		100	MHz
Output High Voltage <sup>1,2</sup>	$V_{OH}$	HCSL		785	850	mV
Output Low Voltage <sup>1,2</sup>	$V_{OL}$	HCSL	-150	11		mV
Crossing Point Voltage <sup>1,2</sup>		Absolute	250	381	550	mV
Crossing Point Voltage <sup>1,2,4</sup>		Variation over all edges		92	140	mV
Jitter, Cycle-to-Cycle <sup>1,3</sup>				33	50	ps
Frequency Synthesis Error		All outputs		0		ppm
Modulation Frequency		Spread spectrum	30	32.9	33	kHz
Rise Time <sup>1,2</sup>	$t_{OR}$	From 0.175 V to 0.525 V	175	325	700	ps
Fall Time <sup>1,2</sup>	$t_{OF}$	From 0.525 V to 0.175 V	175	403	700	ps
Rise/Fall Time Variation <sup>1,2</sup>				78	125	ps
Output to Output Skew				44	50	ps
Duty Cycle <sup>1,3</sup>			45	51	55	%
Output Enable Time <sup>5</sup>		All outputs		38	100	ns
Output Disable Time <sup>5</sup>		All outputs		30	100	ns
Stabilization Time	$t_{STABLE}$	From power-up $V_{DD}=3.3\text{ V}$		0.9	1.8	ms
Spread Spectrum Transition Time	$t_{SPREAD}$	Stabilization time after spread spectrum changes	3		30	ms

<sup>1</sup> Test setup is  $R_S=33\Omega$ ,  $R_P=50\Omega$  with  $C_L=2\text{ pF}$ ,  $R_r = 475\Omega$  (1%).

<sup>2</sup> Measurement taken from a single-ended waveform.

<sup>3</sup> Measurement taken from a differential waveform.

<sup>4</sup> Measured at the crossing point where instantaneous voltages of both CLKOUT and  $\overline{\text{CLKOUT}}$  are equal.

<sup>5</sup> CLKOUT pins are tri-stated when OE is asserted low. CLKOUT is driven differential when OE is high unless its  $\overline{\text{PD}}$  is low.

## Electrical Characteristics - Phase Jitter

Parameter	Symbol	Conditions	Min	Typ	Max	Units	Notes
Jitter, Phase	$t_{j\text{phaseG1}}$	PCIe Gen1		40	86	ps (p-p)	1,2,3
	$t_{j\text{phaseG2Lo}}$	PCIe Gen2, 10 kHz < f < 1.5 MHz		1.2	3	ps (RMS)	1,2,3
	$t_{j\text{phaseG2High}}$	PCIe Gen2, 1.5 MHz < f < Nyquist (50 MHz)		2.7	3.1	ps (RMS)	1,2,3
	$t_{j\text{phase}}$	PCIe Gen3		0.7	1	ps (RMS)	1,2,3

Note 1. Guaranteed by design and characterization, not 100% tested in production.

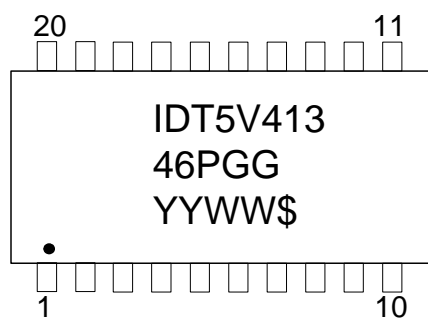
Note 2. See <http://www.pcisig.com> for complete specs.

Note 3. Applies to 100MHz, spread off and 0.5% down spread only.

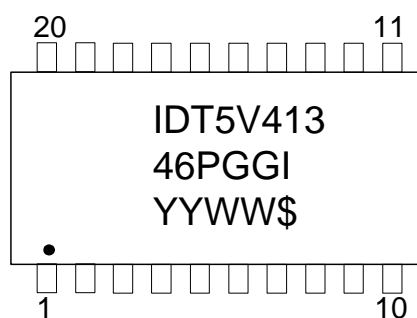
## Thermal Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Thermal Resistance Junction to Ambient	$\theta_{JA}$	Still air		93		°C/W
	$\theta_{JA}$	1 m/s air flow		78		°C/W
	$\theta_{JA}$	3 m/s air flow		65		°C/W
Thermal Resistance Junction to Case	$\theta_{JC}$			20		°C/W

### Marking Diagram (5V41346PGG)



### Marking Diagram (5V41346PGGI)

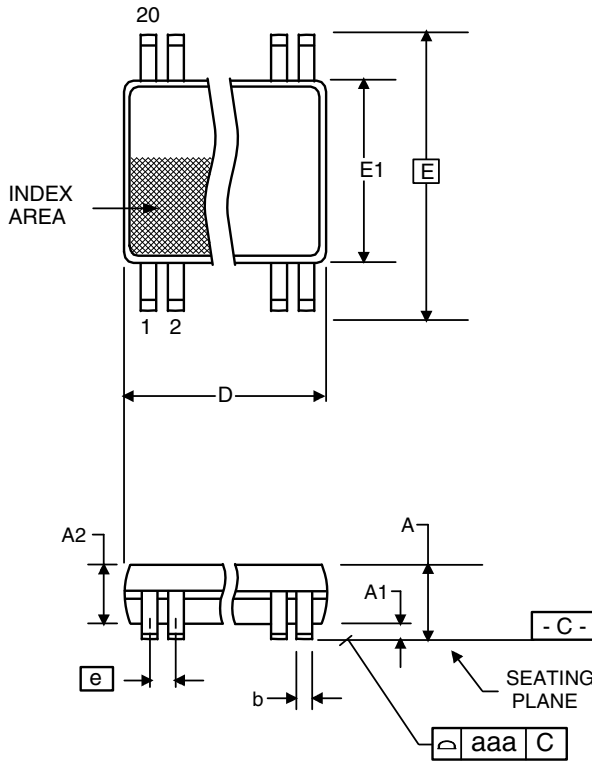


Notes:

1. Line 1 and 2: IDT part number.
2. Line 3: YYWW – Date code; \$ – Assembly location.
3. “G” after the two-letter package code designates RoHS compliant package.
4. “I” at the end of part number indicates industrial temperature range.
5. Bottom marking: country of origin if not USA.

### Package Outline and Package Dimensions (20-pin TSSOP, 173 mil Body)

Package dimensions are kept current with JEDEC Publication No. 95, MO-153



Symbol	Millimeters		Inches*	
	Min	Max	Min	Max
A		1.20		0.047
A1	0.05	0.15	0.002	0.006
A2	0.80	1.05	0.032	0.041
b	0.19	0.30	0.007	0.012
c	0.09	0.20	0.0035	0.008
D	6.40	6.60	0.252	0.260
E	6.40 BASIC		0.252 BASIC	
E1	4.30	4.50	0.169	0.177
e	0.65 Basic		0.0256 Basic	
L	0.45	0.75	0.018	0.030
a	0°	8°	0°	8°
aaa	--	0.10	--	0.004

### Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
5V41346PGG	see page 10	Tubes	20-pin TSSOP	0 to +70°C
5V41346PGG8		Tape and Reel	20-pin TSSOP	0 to +70°C
5V41346PGGI		Tubes	20-pin TSSOP	-40 to +85°C
5V41346PGGI8		Tape and Reel	20-pin TSSOP	-40 to +85°C

“G” after the two-letter package code are the Pb-Free configuration and are RoHS compliant.

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## Revision History

Rev.	Date	Originator	Description of Change
A	08/29/13	J. Chao	Initial release.
B	07/24/14	RDW	<ol style="list-style-type: none"><li>1. Updates to front page output features and key specifications</li><li>2. Remove "On-chip Capacitors" section</li><li>3. Added/updated typical values to all electrical tables per characterization report and review.</li><li>4. Add commercial temp specs to all electrical tables.</li><li>5. Updated marking diagrams.</li><li>6. Move from Prelim to Final</li></ol>

**IDT5V41346**

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